TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

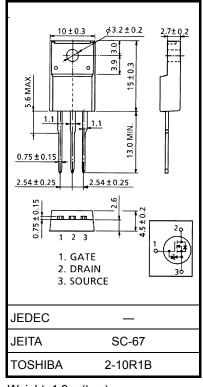
2SK3310

Switching Regulator Applications

- Low drain-source ON resistance: $RDS(ON) = 0.48 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 4.3 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 450 \ V)$
- Enhancement model: $V_{th} = 3.0 \sim 5.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ID} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	450	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	450	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	۱ _D	10	Α	
	Pulse (Note 1)	I _{DP}	40	~	
Drain power dissipat	ion (Tc = 25°C)	PD	40	W	
Single pulse avalanche energy (Note 2)		E _{AR}	222	mJ	
Avalanche current		I _{AR}	10	А	
Repetitive avalanche energy (Note 3)		E _{AR}	4	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 3.7 mH, R_G = 25 Ω , I_{AR} = 10 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

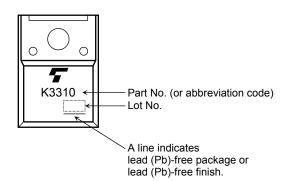
Electrical Characteristics (Ta = 25°C)

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$			±10	μA
Gate -source breakdown voltage		V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30			V
Drain cut-off current		I _{DSS}	$V_{DS} = 450 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		100	μA
Drain-source brea	kdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	450			V
Gate threshold vo	Itage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	3.0		5.0	V
Drain-source ON resistance		R _{DS (ON)}	$V_{GS}=10~V,~I_D=5~A$	_	0.48	0.65	Ω
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	1.5	4.3		S
Input capacitance		C _{iss}		_	920		pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz$	_	12		
Output capacitance		C _{oss}		_	140		
Switching time	Rise time	tr	$V_{GS}^{10 \text{ V}} \downarrow_{DD} = 5 \text{ A} \\ V_{GS}^{0 \text{ V}} \downarrow_{DD} = 5 \text{ A} \\ R_{L} = 40 \Omega \\ V_{DD} \approx 200 \text{ V} \\ Duty \leq 1\%, t_{W} = 10 \mu s$	_	25		- ns
	Turn-on time	t _{on}		_	35		
	Fall time	t _f		_	10	_	
	Turn-off time	t _{off}		_	60		
Total gate charge		Qg			23		nC
Gate-source charge		Q _{gs}	$V_{DD}\simeq 360~V,~V_{GS}=10~V,~I_{D}=10~A$	_	9		
Gate-drain charge		Q _{gd}			14		

Source-Drain Ratings and Characteristics (Ta = 25°C)

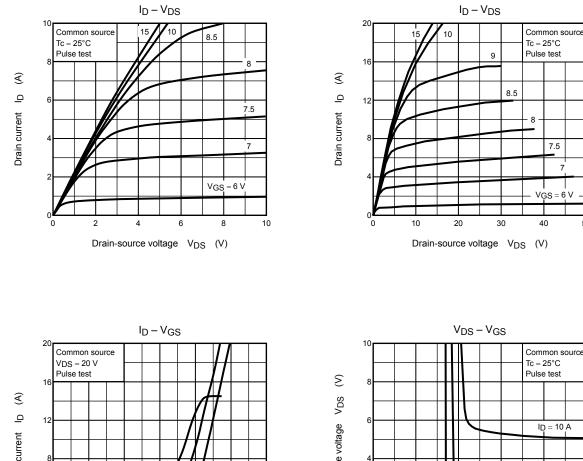
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_		10	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_		40	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V,	_	280	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs		2.7	_	μC

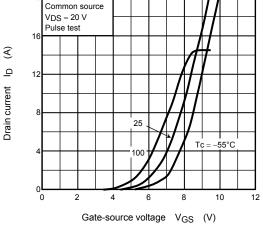
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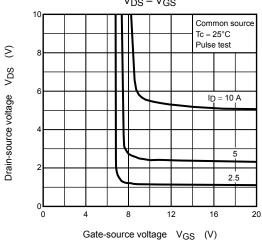


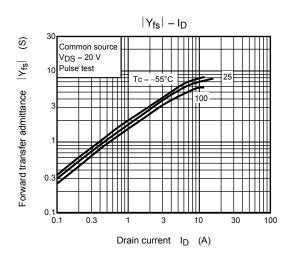
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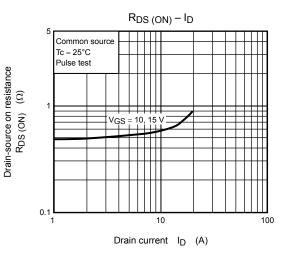
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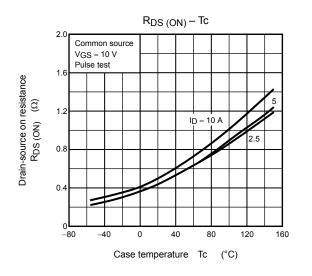


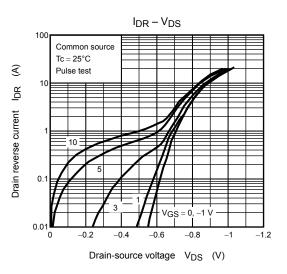


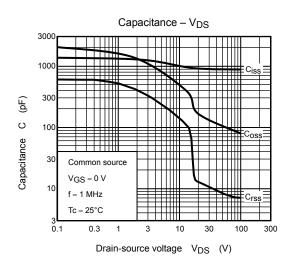


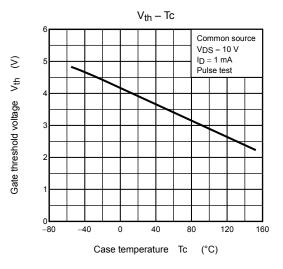


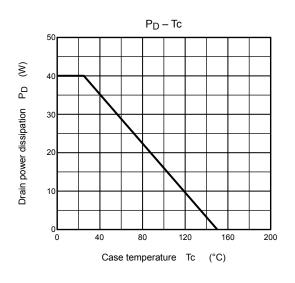
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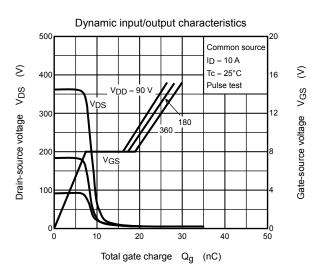


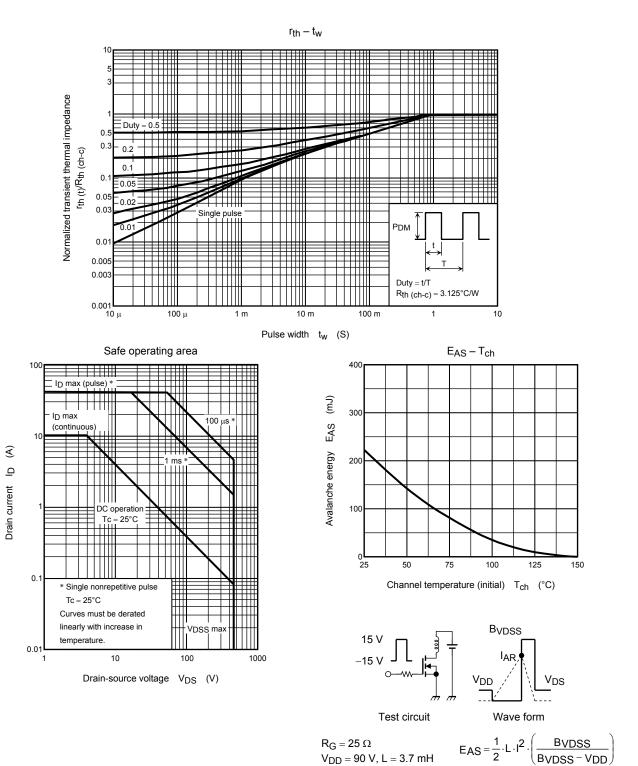












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